NEC

DATA SHEET

MOS FIELD EFFECT TRANSISTOR NP100P04PDG

SWITCHING **P-CHANNEL POWER MOSFET**

DESCRIPTION

The NP100P04PDG is P-channel MOS Field Effect Transistor designed for high current switching applications.

ORDERING INFORMATION <R>

| PART NUMBER | LEAD PLATING | PACKING | PACKAGE | |
|------------------------|-----------------------------------|-----------------|------------------|--|
| NP100P04PDG-E1-AY Note | | Tape 800 p/reel | | |
| NP100P04PDG-E2-AY Note | 00P04PDG-E2-AY Note Pure Sn (Tin) | | TO-263 (MP-25ZP) | |

Note Pb-free (This product does not contain Pb in external electrode.)

FEATURES

• Super low on-state resistance

 $R_{DS(on)1} = 3.5 \text{ m}\Omega \text{ MAX.}$ (Vgs = -10 V, ID = -50 A)

 $R_{DS(on)2} = 5.1 \text{ m}\Omega \text{ MAX.}$ (Vgs = -4.5 V, ID = -50 A)

• High current rating: ID(DC) = ∓100 A

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

| Drain to Source Voltage (VGs = 0 V) | VDSS | -40 | V |
|---|-------------|-------------|----|
| Gate to Source Voltage (VDS = 0 V) | Vgss | ∓20 | V |
| Drain Current (DC) (Tc = 25°C) | D(DC) | ∓100 | А |
| Drain Current (pulse) ^{Note1} | D(pulse) | ∓300 | А |
| Total Power Dissipation (Tc = 25°C) | P T1 | 200 | W |
| Total Power Dissipation (T _A = 25°C) | Pt2 | 1.8 | W |
| Channel Temperature | Tch | 175 | °C |
| Storage Temperature | Tstg | –55 to +175 | °C |
| Single Avalanche Current Note2 | las | 74 | А |
| Single Avalanche Energy Note2 | Eas | 550 | mJ |

Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1%

2. Starting T_{ch} = 25°C, V_{DD} = -30 V, R_G = 25 Ω , V_{GS} = $-20 \rightarrow 0$ V

THERMAL RESISTANCE

| Channel to Case Thermal Resistance | Rth(ch-C) | 0.75 | °C/W |
|---------------------------------------|-----------|------|------|
| Channel to Ambient Thermal Resistance | Rth(ch-A) | 83.3 | °C/W |

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(TO-263)

The mark <R> shows major revised points.

The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

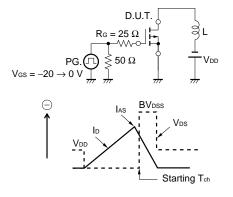
| CHARACTERISTICS | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|--|---------------------|--|------|-------|-------------|------|
| Zero Gate Voltage Drain Current | IDSS | V _{DS} = -40 V, V _{GS} = 0 V | | | -10 | μA |
| Gate Leakage Current | Igss | V _{GS} = ∓20 V, V _{DS} = 0 V | | | ∓100 | nA |
| Gate to Source Threshold Voltage | V _{GS(th)} | V _{DS} = -10 V, I _D = -1 mA | -1.0 | -1.6 | -2.5 | V |
| Forward Transfer Admittance Note | y _{fs} | V _{DS} = -10 V, I _D = -50 A | 43 | 88 | | S |
| Drain to Source On-state Resistance Note | RDS(on)1 | V _{GS} = −10 V, I _D = −50 A | | 2.8 | 3.5 | mΩ |
| | RDS(on)2 | V _{GS} = -4.5 V, I _D = -50 A | | 3.4 | 5.1 | mΩ |
| Input Capacitance | Ciss | V _{DS} = -10 V, | | 15100 | | pF |
| Output Capacitance | Coss | V _{GS} = 0 V, | | 2400 | | pF |
| Reverse Transfer Capacitance | Crss | f = 1 MHz | | 1130 | | pF |
| Turn-on Delay Time | td(on) | V_{DD} = -20 V, I _D = -45 A, | | 38 | | ns |
| Rise Time | tr | V _{GS} = -10 V, | | 30 | | ns |
| Turn-off Delay Time | td(off) | Rg = 0 Ω | | 300 | | ns |
| Fall Time | tr | | | 100 | | ns |
| Total Gate Charge | QG | V _{DD} = -32 V, | | 320 | | nC |
| Gate to Source Charge | QGS | V _{GS} = -10 V, | | 37 | | nC |
| Gate to Drain Charge | Qgd | I⊳ = −100 A | | 85 | | nC |
| Body Diode Forward Voltage Note | V _{F(S-D)} | IF = -100 A, VGS = 0 V | | 0.91 | 1.5 | V |
| Reverse Recovery Time | trr | I⊧ = −100 A, V₀s = 0 V, | | 70 | | ns |
| Reverse Recovery Charge | Qrr | di/dt = −100 A/ <i>µ</i> s | | 123 | | nC |

ELECTRICAL CHARACTERISTICS (TA = 25°C)

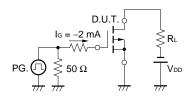
Note Pulsed test PW \leq 350 μ s, Duty Cycle \leq 2%

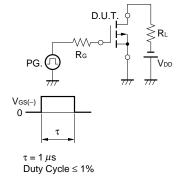
TEST CIRCUIT 1 AVALANCHE CAPABILITY

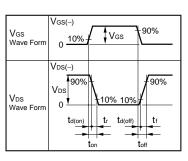
TEST CIRCUIT 2 SWITCHING TIME



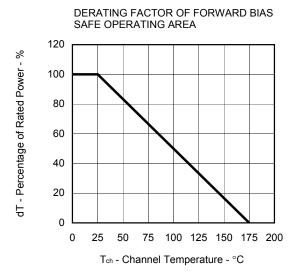
TEST CIRCUIT 3 GATE CHARGE



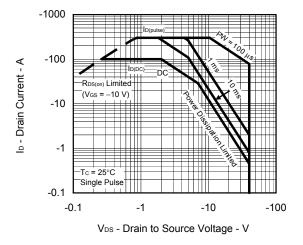


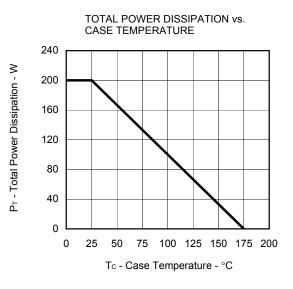


TYPICAL CHARACTERISTICS (TA = 25°C)

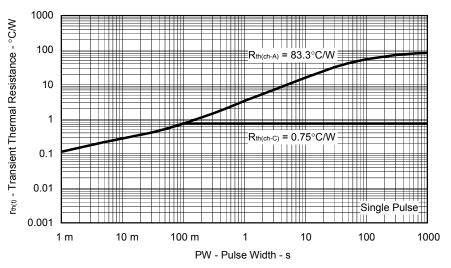






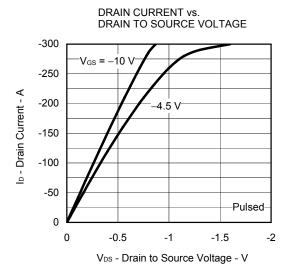


TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

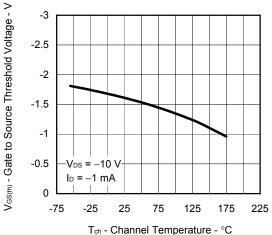


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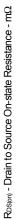


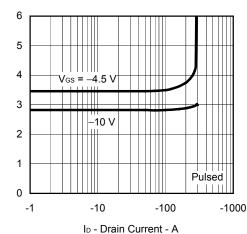




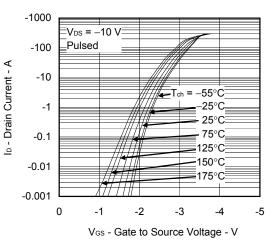


DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

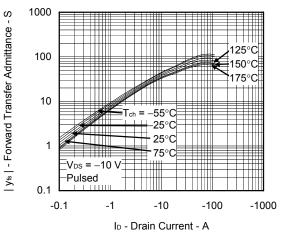




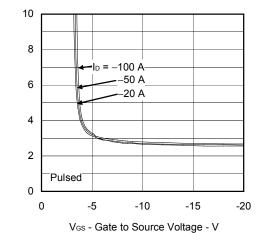




FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



 $R_{DS(on)}$ - Drain to Source On-state Resistance - $m\Omega$

-1

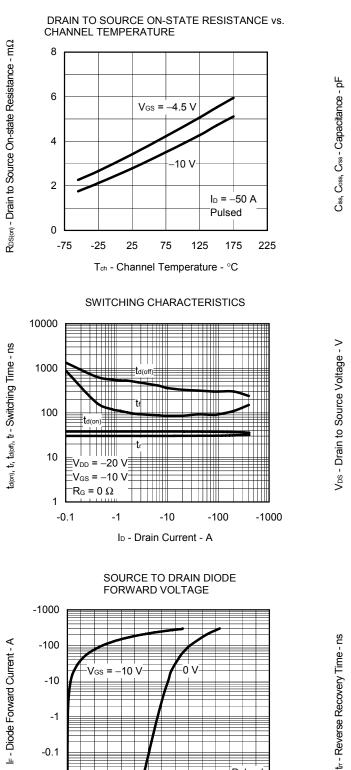
-0.1

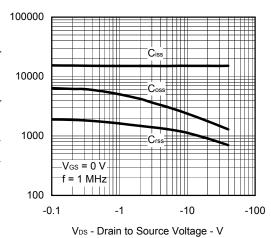
-0.01

0

0.5

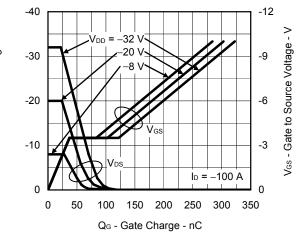
VF(S-D) - Source to Drain Voltage - V



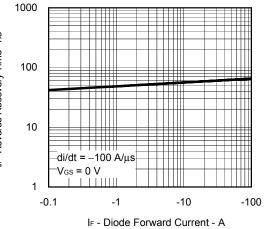


CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE

DYNAMIC INPUT/OUTPUT CHARACTERISTICS



REVERSE RECOVERY TIME vs. DIODE FORWARD CURRENT

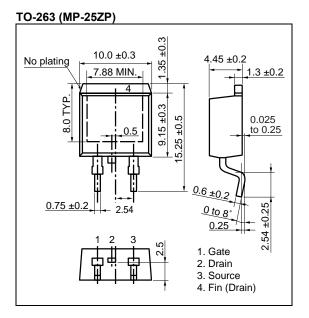


Pulsed

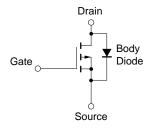
1.5

1

PACKAGE DRAWING (Unit: mm)



EQUIVALENT CIRCUIT



Remark Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

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